

List

Lable Sign	Manufacturing Type	Price	Printing Quality	Continues Printing	0.4 pitch QFP QFP	0402 Chip	Quality	Features
L	Laser Cutting	⊙	○	○	△	×	⊙	High quality cutting, applicable on any stencil.Well balanced QCD.
KF-L	Laser Cutting + Electropolishing	○	⊙	○	○	△	⊙	Minimum distortions to effect printing quality
FC-L	Laser Cutting + Thin Fluorine Coating	○	○	⊙	○	△	⊙	Water-repellent applied on the back and inner side of laser cutted stencil.
FC-K-L	Laser Cutting + Thin Fluorine Coating + Electropolishing	△	⊙	⊙	⊙	⊙	⊙	The highest specification we can offer with all of the best qualities.
TF-L	Laser Cutting + Thick Fluorine Coating	○	○	⊙	△	×	○	High Water-repellent applied on the back and inner side of laser cutted stencil .
TF-K-L	Laser Cutting + Thick Fluorine Coating + Electropolishing	△	⊙	⊙	○	×	○	Minimum distortions and high water-repellent on the back and inner side.
E	Chemical Eching	⊙	△	×	×	×	△	One cutting process, thus number of cutting does not affect the price.
KF-E	Chemical Etching + Electropolishing	○	○	○	△	△	△	Minimize the distortion to lessen the effect of printing quality.
FC-E	Chemical Etching + Thick Fluorine Coating	○	△	⊙	△	△	△	Water-repellent applied on the back and inner side of chemical eched stencil.
FC-K-E	Chemical Etching + Thick Fluorine Coating + Electropolishing	△	○	⊙	○	○	△	Best for multiple cutting and clean printing. ex) printing flux.
TF-E	Chemical Eching + Thic Fluorin Coating	○	△	⊙	△	×	△	High Water-repellent applied on the back and inner side of chemical etched stencil.
TF-K-E	Chemical Etching + Thick Fluorine Coating + Electropolishing	△	○	⊙	○	×	△	Best for multiple cutting and clean printing. ex) printing glue
A	Additive	△	○	○	○	○	○	Applicable on wide range of thickness, good printing quality.
FC-A	Additive + Thin Fluorine Coating	×	⊙	⊙	⊙	⊙	○	Water-repellent applied on the back and inner side of electroformed stencil.
TF-A	Additive + Thick Fluorine Coating	×	⊙	⊙	○	×	△	High Water-repellent applied on the back and inner side of electroformed stencil.